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PATENT &amp; TRADEMARK OFFICE

## DECLARATION AND POWER OF ATTORNEY - ORIGINAL APPLICATION

ATTORNEY'S DOCKET NO.

12301/2

As a below named inventor, I hereby declare that:  
 My residence, post office address and citizenship are as stated below next to my name.  
 I believe I am the original, first and sole inventor (if only one name is listed below) or  
 an original, first and joint inventor (if plural names are listed below) of the subject matter which  
 is claimed and for which a patent is sought on the invention entitled POLARIZING MOLDED  
ARTICLE AND PROCESS FOR PREPARING THE SAME

the specification of which

(check one)

is attached hereto.

was filed on December 20, 2001 as Application Serial No. \_\_\_\_\_ and was  
 amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified  
 specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this  
 application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any  
 foreign application(s) for patent or inventor's certificate listed below and have also identified  
 below any foreign application for patent or inventor's certificate having a filing date before that  
 of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

COUNTRY	APPLICATION NUMBER	DATE OF FILING (day, month, year)	DATE OF ISSUE (day, month, year)	PRIORITY CLAIMED UNDER 35 USC 119
Japan	2000-387224	20,12,2000		<input checked="" type="checkbox"/> YES <input type="checkbox"/> NO
				<input type="checkbox"/> YES <input type="checkbox"/> NO

I hereby claim the benefit under Title 35, United States Code, §120 of any United States  
 application(s) listed below and, insofar as the subject matter of each of the claims of this  
 application is not disclosed in the prior United States application in the manner provided by the  
 first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material  
 information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the  
 filing date of the prior application and the national or PCT international filing date of this  
 application:

APPLICATION NO.	FILING DATE (day, month, year)	STATUS (i.e. Patented, Pending, Abandoned)

**POWER OF ATTORNEY:** As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this  
 application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

Edward W. Greason, Esq.  
 Reg. No. 18,918

SEND CORRESPONDENCE TO:	DIRECT TELEPHONE CALL TO : (name and telephone number)
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PATENT TRADEMARK OFFICE

(continued)

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212	POST OFFICE ADDRESS	CITY	STATE & ZIP CODE/COUNTRY	
213	FULL NAME OF INVENTOR	FAMILY NAME	FIRST GIVEN NAME	SECOND GIVEN NAME
214	RESIDENCE & CITIZENSHIP CITY	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZENSHIP	STATE & ZIP CODE/COUNTRY
215	POST OFFICE ADDRESS	CITY	STATE & ZIP CODE/COUNTRY	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

SIGNATURE OF INVENTOR 201

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DATE

December 26, 2001

DATE

December 26, 2001

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December 26, 2001

SIGNATURE OF INVENTOR 204

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